NVBLS0D5N04M8

MOSFET – Power, Single, N-Channel

40 V, 300 A, 0.57 m Ω

Features

- Typical $R_{DS(on)} = 0.46 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- Typical $Q_{g(tot)} = 220 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- UIS Capability
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS $T_J = 25^{\circ}C$ unless otherwise noted

Parameter	Symbol	Ratings	Units
Drain-to-Source Voltage	V _{DSS}	40	V
Gate-to-Source Voltage	V _{GS}	±20	V
Drain Current – Continuous (V _{GS} = 10) (Note 1) T _C = 25°C	۱ _D	300	A
Pulsed Drain Current $T_{C} = 25^{\circ}C$		See Figure 4	
Single Pulse Avalanche Energy (Note 2)	E _{AS}	1064	mJ
Power Dissipation	PD	429	W
Derate Above 25°C		2.86	W/°C
Operating and Storage Temperature	T _J , T _{STG}	–55 to +175	°C
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.35	°C/W
Maximum Thermal Resistance, Junction-to-Ambient (Note 3)	$R_{ hetaJA}$	43	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Current is limited by bondwire configuration.
- 2. Starting $T_J = 25^{\circ}$ C, $\dot{L} = 0.3$ mH, $I_{AS} = 84$ A, $V_{DD} = 40$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.
- 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2 oz copper.

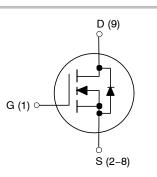


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MO-299A CASE 100CU



ORDERING INFORMATION

	Device	Package	Marking
NVBL	S0D5N04M8TXG	MO-299A (Pb-Free)	0D5N04M8

NVBLS0D5N04M8

Table 1. ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Symbol	Parameter	Test Cor	Test Conditions		Тур	Max	Units
OFF CH	ARACTERISTICS				4		
B_{VDSS}	Drain-to-Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$		40	-	-	V
I _{DSS} [Drain-to-Source Leakage Current	V _{DS} = 40 V,	T _J = 25°C	-	-	1	μA
		$V_{GS} = 0 V$	T _J = 175°C (Note 4)	-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	V _{GS} = ±20 V		-	-	±100	nA
ON CHA	RACTERISTICS					-	
V _{GS(th)}	Gate-to-Source Threshold Voltage	$V_{GS} = V_{DS},$	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		3.0	4.0	V
R _{DS(on)}	Drain-to-Source On Resistance	I _D = 80 A, V _{GS} = 10 V	T _J = 25°C	-	0.46	0.57	mΩ
DYNAMI	C CHARACTERISTICS						
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1 MHz		-	15900	-	pF
Coss	Output Capacitance				4000	-	pF
C _{rss}	Reverse Transfer Capacitance			-	600	-	pF
Rg	Gate Resistance	f = 1 MHz		-	2.6	-	Ω
Q _{g(ToT)}	Total Gate Charge at 10 V	V _{GS} = 0 to 10 V	V _{DD} = 20 V I _D = 80 A	-	220	296	nC
Q _{g(th)}	Threshold Gate Charge	$V_{GS} = 0$ to 2 V		-	29	39	nC
Q_gs	Gate-to-Source Gate Charge		•	-	73	-	nC
Q_{gd}	Gate-to-Drain "Miller" Charge			_	41	-	nC
SWITCH	ING CHARACTERISTICS						
t _{on}	Turn-On Time	$V_{DD} = 20 V$	$V_{DD} = 20 \text{ V}, \text{ I}_{D} = 80 \text{ A}, \\ V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		-	221	ns
t _{d(on)}	Turn-On Delay	V _{GS} = 10 V,			54	-	ns
tr	Rise Time	1		_	82	-	ns
t _{d(off)}	Turn-Off Delay		-		106	-	ns
t _f	Fall Time				52	-	ns
t _{off}	Turn–Off Time				-	215	ns
DRAIN-	SOURCE DIODE CHARACTERISTICS						
V _{SD}	Source-to-Drain Diode Voltage	$I_{SD} = 80 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1.25	V
		I _{SD} = 40 A,	$V_{GS} = 0 V$	-	-	1.2	V
t _{rr}	Reverse-Recovery Time	$I_F = 80 \text{ A}, \text{ dI}_{SD}/\text{d}_t = 100 \text{ A}/\mu\text{s},$		-	119	133	ns
			= 32 V				1

Q_{rr}

Reverse-Recovery Charge

4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production. Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

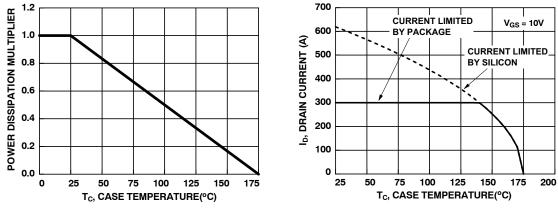
 $V_{DD} = 32 V$

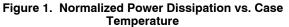
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274

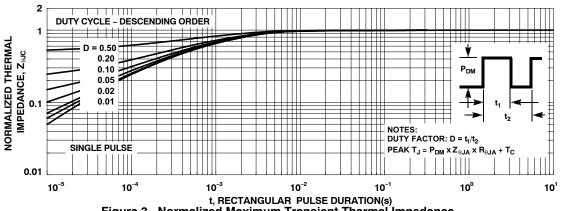
nC

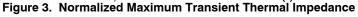
Typical Characteristics











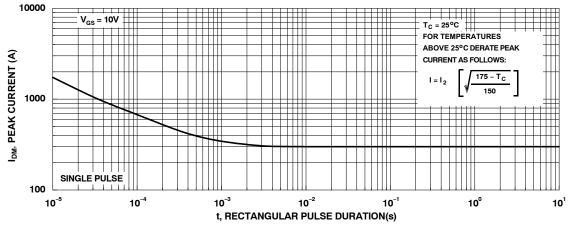


Figure 4. Peak Current Capability

Typical Characteristics

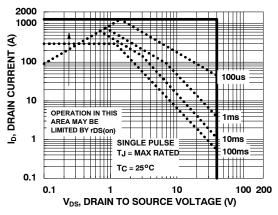
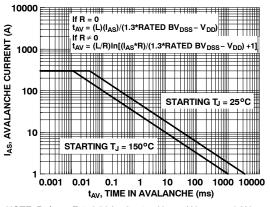
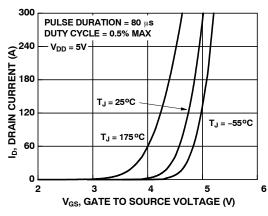


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to Fairchild Application Notes AN7514 and AN7515 Figure 6. Unclamped Inductive Switching Capability





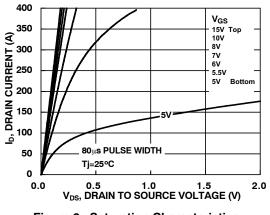


Figure 9. Saturation Characteristics

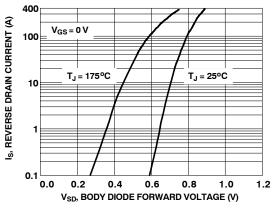
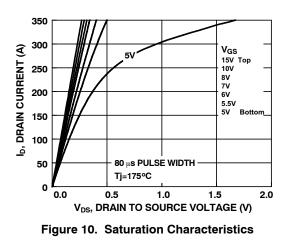


Figure 8. Forward Diode Characteristics



Typical Characteristics

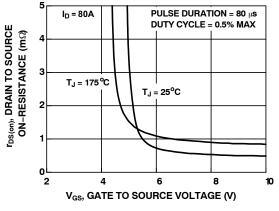
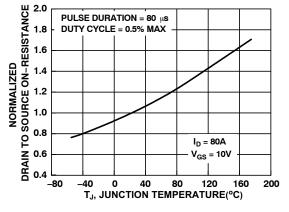
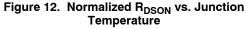


Figure 11. R_{DSON} vs. Gate Voltage





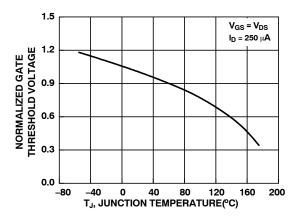


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

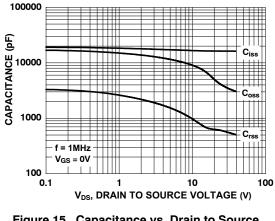
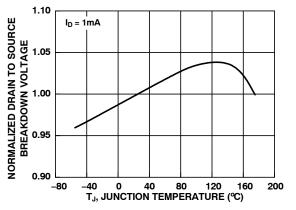
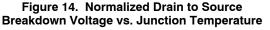
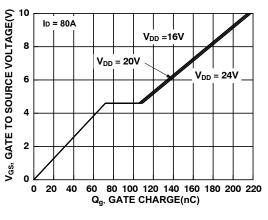


Figure 15. Capacitance vs. Drain to Source Voltage



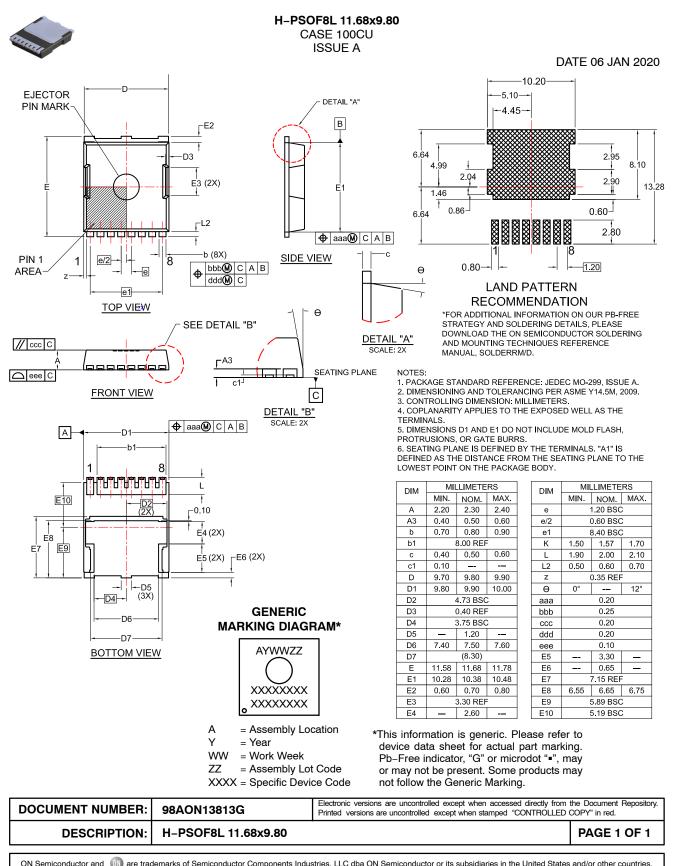






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